# DATA SHEET



# PHOTOCOUPLER **PS8101**

# 1 Mbps HIGH CMR ANALOG OUTPUT TYPE 5-PIN SOP (SO-5) PHOTOCOUPLER

-NEPOC Series-

# DESCRIPTION

The PS8101 is an optically coupled isolator containing a GaAlAs LED on the light emitting diode (input side) and a PIN photodiode and a high-speed amplifier transistor on the output side on one chip.

This is a plastic SOP (Small Out-line Package) type for high density applications.

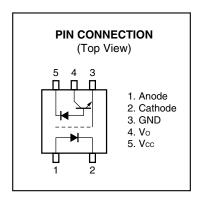
#### **FEATURES**

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- High common mode transient immunity (CMH,  $C_{ML} = \pm 10 \text{ kV}/\mu \text{s MIN.}$ )
- Small package (SO-5)
- High supply voltage (Vcc = 35 V)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- High-speed response (tPHL = 0.8 μs MAX., tPLH = 1.2 μs MAX.)
- Ordering number of taping product: PS8101-F3, F4: 2 500 pcs/reel
- Pb-Free product
- Safety standards
  - UL approved: File No. E72422
  - DIN EN60747-5-2 (VDE0884 Part2) approved: No. 40008902 (Option)

#### **APPLICATIONS**

- Computer and peripheral manufactures
- General purpose inverter
- Substitutions for relays and pulse transformers
- Power supply



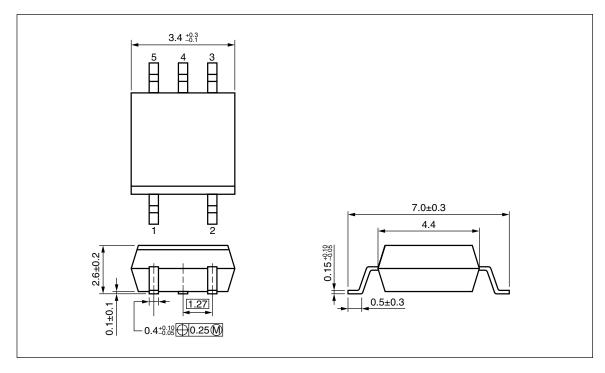
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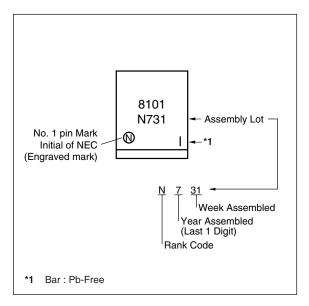
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The mark <R> shows major revised points. The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

# <R> PACKAGE DIMENSIONS (UNIT: mm)



# MARKING EXAMPLE



# **ORDERING INFORMATION**

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number <sup>⁺1</sup>
PS8101	PS8101-A	Pb-Free	20 pcs (Tape 20 pcs cut)	Standard products	PS8101
PS8101-F3	PS8101-F3-A		Embossed Tape 2 500 pcs/reel	(UL approved)	
PS8101-F4	PS8101-F4-A				
PS8101-V	PS8101-V-A		20 pcs (Tape 20 pcs cut)	DIN EN60747-5-2	
PS8101-V-F3	PS8101-V-F3-A		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS8101-V-F4	PS8101-V-F4-A			Approved (Option)	

\*1 For the application of the Safety Standard, following part number should be used.

# ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current	lf	25	mA
	Reverse Voltage	VR	5.0	V
	Power Dissipation <sup>1</sup>	PD	45	mW
Detector	Supply Voltage	Vcc	35	V
	Output Voltage	Vo	35	V
	Output Current	lo	8.0	mA
	Power Dissipation <sup>2</sup>	Pc	100	mW
Isolation Voltage <sup>3</sup>		BV	3 750	Vr.m.s.
Operating Ambient Temperature		TA	–55 to +100	°C
Storage Temperature		Tstg	-55 to +125	°C

\*1 Reduced to 0.45 mW/°C at  $T_A = 25^{\circ}C$  or more.

\*2 Reduced to 1.00 mW/°C at TA =  $25^{\circ}$ C or more.

\*3 AC voltage for 1 minute at  $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-2 shorted together, 3-5 shorted together.

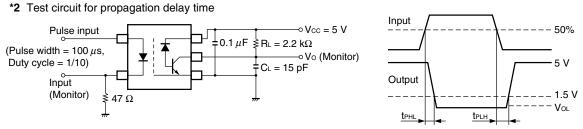
# ELECTRICAL CHARACTERISTICS (TA = 25°C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 16 mA		1.7	2.2	V
	Reverse Current	IR	V <sub>R</sub> = 3 V			10	μA
	Forward Voltage Temperature Coefficient	<i>∆</i> V <i>f/∆</i> Ta	l⊧ = 16 mA		-2.1		mV/°C
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		30		pF
Detector	High Level Output Current	Іон (1)	$I_F = 0 \text{ mA}, \text{ Vcc} = V_0 = 5.5 \text{ V}$		3	500	nA
	High Level Output Current	Іон (2)	IF = 0 mA, Vcc = Vo = 30 V			100	μA
	Low Level Output Voltage	Vol	IF = 16 mA, Vcc = 4.5 V, Io = 1.2 mA		0.1	0.4	V
	Low Level Supply Current	Iccl	$I_F$ = 16 mA, Vo = open, Vcc = 30 V		50		μA
	High Level Supply Current	Іссн	IF = 0 mA, Vo = open, Vcc = 30 V		0.01	2	
Coupled	Current Transfer Ratio <sup>1</sup>	CTR	$I_{\text{F}}$ = 16 mA, Vcc = 4.5 V, Vo = 0.4 V	15	20	35	%
	Isolation Resistance	Ri-o	$V_{I-O} = 1 \text{ kV}_{DC}, \text{ RH} = 40 \text{ to } 60\%$	10 <sup>11</sup>			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		0.4		pF
	Propagation Delay Time $(H \rightarrow L)^{2}$	tph∟	$\label{eq:lf} \begin{array}{l} I_{F} = 16 \text{ mA},  V_{\mathrm{CC}} = 5  V,  R_{L} = 2.2  k\Omega, \\ C_{L} = 15  pF \end{array}$		0.5	0.8	μs
	Propagation Delay Time $(L \rightarrow H)^{2}$	tрін			0.6	1.2	
	Common Mode Transient Immunity at High Level Output <sup>3</sup>	Смн	$I_{\text{F}} = 0 \text{ mA}, \text{ V}_{\text{CC}} = 5 \text{ V}, \text{ R}_{\text{L}} = 4.1 \text{ k}\Omega,$ $V_{\text{CM}} = 1.5 \text{ kV}$	10			kV/μs
	Common Mode Transient Immunity at Low Level Output <sup>3</sup>	Смг	$I_{\text{F}} = 16 \text{ mA}, \text{ V}_{\text{CC}} = 5 \text{ V}, \text{ R}_{\text{L}} = 4.1 \text{ k}\Omega,$ $V_{\text{CM}} = 1.5 \text{ kV}$	-10			

\*1 CTR rank

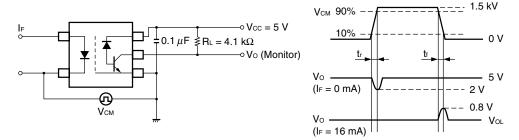
K : 20 to 35 (%)

N : 15 to 35 (%)



CL is approximately 15 pF which includes probe and stray wiring capacitance

\*3 Test circuit for common mode transient immunity



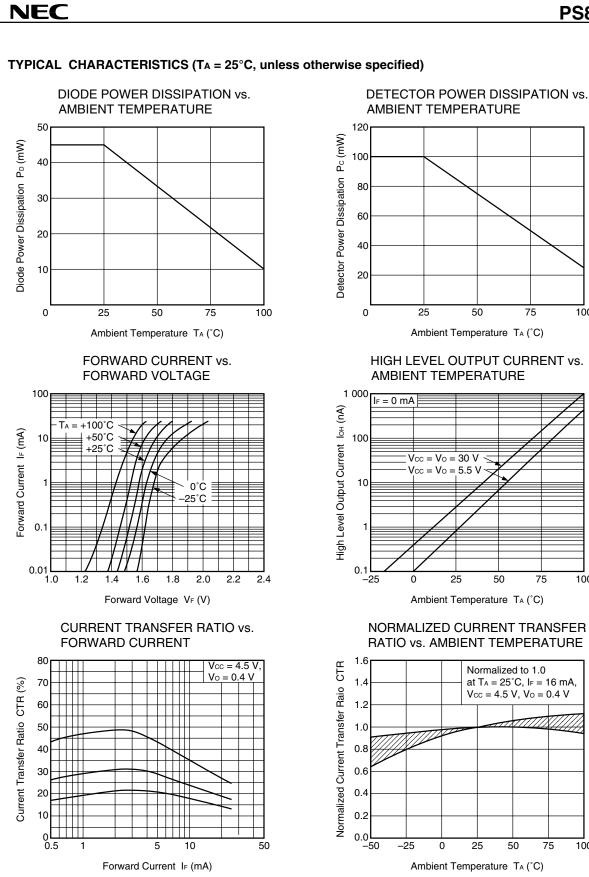
# USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1  $\mu$ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.

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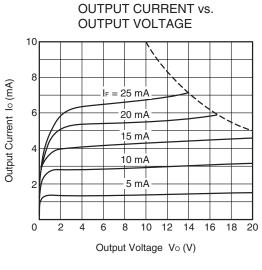
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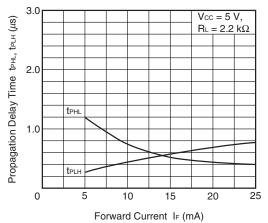


Remark The graphs indicate nominal characteristics.

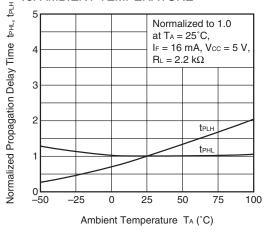
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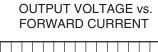




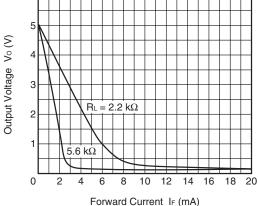




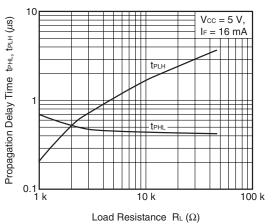
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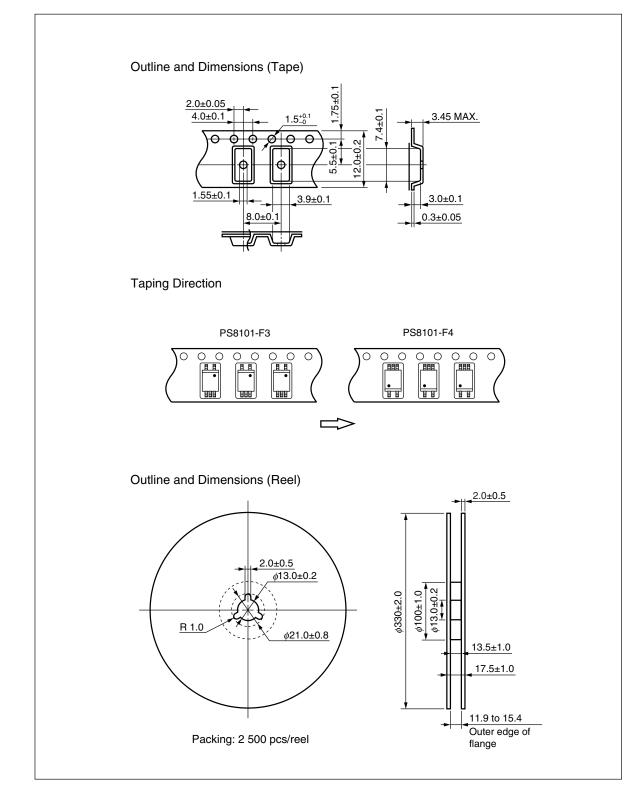
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PROPAGATION DELAY TIME vs. LOAD RESISTANCE



# TAPING SPECIFICATIONS (UNIT: mm)



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#### NOTES ON HANDLING

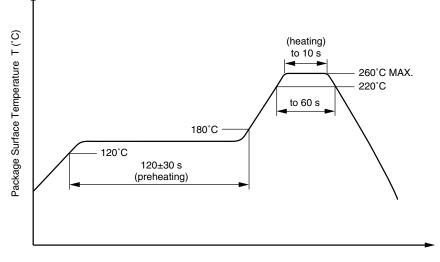
#### 1. Recommended soldering conditions

#### (1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to  $180^\circ\text{C}$
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

#### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### (3) Soldering by Soldering Iron

Peak Temperature (lead part temperature)	350°C or below
<ul> <li>Time (each pins)</li> </ul>	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over  $100^{\circ}C$

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#### (4) Cautions

# • Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

#### 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

# **USAGE CAUTIONS**

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.